

Preliminary

7A, 700V N-CHANNEL POWER MOSFET

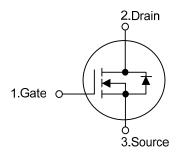
DESCRIPTION

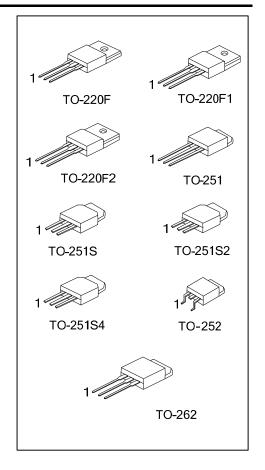
The **UTC 7N70K-MTQ** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 1.7 Ω @ V_{GS} = 10V, I_D = 3.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL



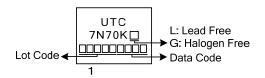


ORDERING INFORMATION

Ordering	Dookago	Pin Assignment			Decking		
Lead Free	Halogen Free	Package	1	2 3		Packing	
7N70KL-TF3-T	7N70KG-TF3-T	TO-220F	G	D	S	Tube	
7N70KL-TF1-T	7N70KG-TF1-T	TO-220F1	G	D	S	Tube	
7N70KL-TF2-T	7N70KG-TF2-T	TO-220F2	G	D	S	Tube	
7N70KL-TM3-T	7N70KG-TM3-T	TO-251	G	D	S	Tube	
7N70KL-TMS-T	7N70KG-TMS-T	TO-251S	G	D	S	Tube	
7N70KL-TMS2-T	7N70KG-TMS2-T	TO-251S2	G	D	S	Tube	
7N70KL-TMS4-T	7N70KG-TMS4-T	TO-251S4	G	D	S	Tube	
7N70KL-TN3-R	7N70KG-TN3-R	TO-252	G	D	S	Tape Reel	
7N70KL-T2Q-T	7N70KG-T2Q-T	TO-262	G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source							
7N70KG-TF3-T	(1) T: Tube, R: Ta	ape Reel					

	(1) 1. Tube, π . Tape π eet
(1)Packing Type	(2) TF3: TO-220F, TF1: TO-220F1,TF2: TO-220F2
(2)Package Type	TM3: TO-251, TMS: TO-251S, TMS2: TO-251S2
	TMS4: TO-251S4, TN3: TO-252, T2Q: TO-262
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	ID	7.0	А
	Pulsed (Note 2)	I _{DM}	28	А
Avalanche Current (Not	e 2)	I _{AR}	6.4	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	205	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
•	TO-220F/TO-220F1 TO-220F2		48	W
Power Dissipation	TO-251/TO-251S TO-251S2/TO-251S4 TO-252	P _D	57	w
	TO-262		142	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

- 3. L = 10mH, I_{AS} = 6.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 7.0A$, di/dt $\le 200A/\mu$ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAM	ETER	SYMBOL	RATINGS	UNIT
	TO-220F/TO-220F1 TO-220F2/TO-262		62.5	°C/W
Junction to Ambient	TO-251/TO-251S TO-251S2/TO-251S4 TO-252	θ _{JA}	110	°C/W
	TO-220F/TO-220F1		2.6	°C/W
	TO-220F2		2.5	°C/W
Junction to Case	TO-251/TO-251S TO-251S2/TO-251S4 TO-252	θ _{JC}	2.2	°C/W
	TO-262		0.88	°C/W

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■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

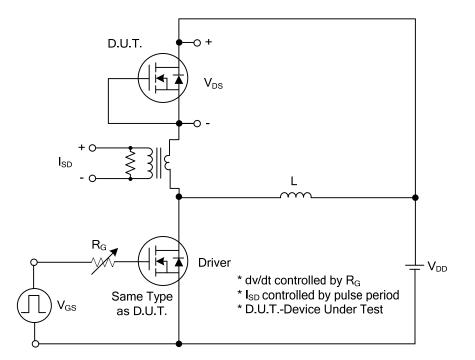
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS					1		
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250µA	700			V
Drain-Source Leakage Current	-	I _{DSS}	V _{DS} = 700V, V _{GS} = 0V	1		1	μA
Gate-Source Leakage Current	Forward	I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		V_{GS} = -30V, V_{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Drain-Source ON-State Resistance	e	R _{DS(ON)}	V _{GS} = 10V, I _D = 3.5A			1.7	Ω
DYNAMIC CHARACTERISTICS			_				
Input Capacitance	Input Capacitance				480		рF
Dutput Capacitance		C _{OSS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		80		pF
Reverse Transfer Capacitance		C _{RSS}			6.5		рF
SWITCHING CHARACTERISTIC	S		_				
Total Gate Charge (Note 1)		Q_{G}	V _{DS} = 50V,I _D = 1.3A,		21.8		nC
Gate to Source Charge		Q_{GS}	V _{DS} = 50V,I _D = 1.3A, V _{GS} = 10V (Note 1, 2)		6.8		nC
Gate to Drain Charge		Q_{DD}	V_{GS} = 10V (NOLE 1, 2)		4.8		nC
Turn-on Delay Time (Note 1)		t _{D(ON)}			57		ns
Rise Time		t _R	V _{DD} = 30V, I _D = 0.5A,		60		ns
Turn-off Delay Time		t _{D(OFF)}	R _G = 25Ω (Note 1, 2)		128		ns
Fall-Time		t⊧			52		ns
SOURCE- DRAIN DIODE RATIN	GS AND CH	ARACTERIS	TICS				
Maximum Body-Diode Continuous	s Current	Is				7.0	Α
Maximum Body-Diode Pulsed Current		I _{SM}				28	Α
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =7.0A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)			I _S =7.0A, V _{GS} =0V,		320		ns
Reverse Recovery Charge		Qrr	dI _F /dt =100A/µs		2.4		μC
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Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%.

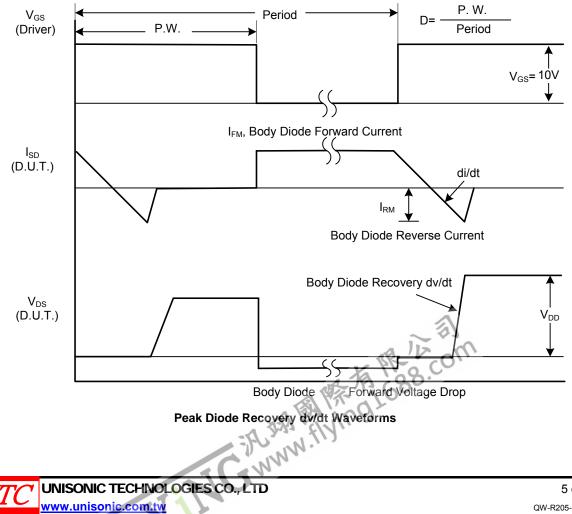
2. Essentially independent of operating temperature.

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TEST CIRCUITS AND WAVEFORMS

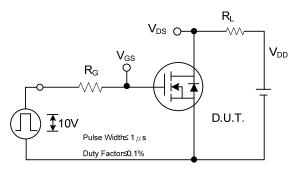


Peak Diode Recovery dv/dt Test Circuit

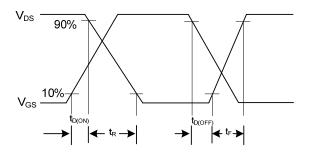


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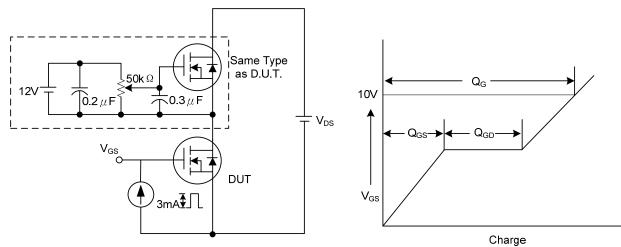
TEST CIRCUITS AND WAVEFORMS (Cont.)



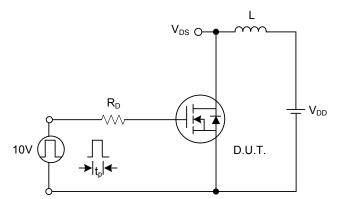
Switching Test Circuit



Switching Waveforms

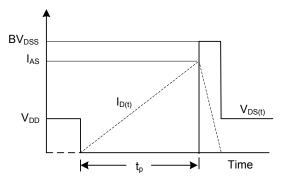


Gate Charge Test Circuit



Unclamped Inductive Switching Test Circuit

Gate Charge Waveform



-REALER PARTIES IN THE COM Unclamped Inductive Switching Waveforms

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